

Silicon Carbide (SiC) MOSFET - EliteSiC, 57 mohm, 650 V, M2, TO-247-4L

NTH4L075N065SC1

Features

- Typ. $R_{DS(on)} = 57 \text{ m}\Omega$ @ $V_{GS} = 18 \text{ V}$ Typ. $R_{DS(on)} = 75 \text{ m}\Omega$ @ $V_{GS} = 15 \text{ V}$
- Ultra Low Gate Charge (Q_{G(tot)} = 61 nC)
- Low Output Capacitance (Coss = 107 pF)
- 100% Avalanche Tested
- $T_J = 175^{\circ}C$
- This Device is Halide Free and RoHS Compliant with exemption 7a, Pb-Free 2LI (on second level interconnection)

Typical Applications

- SMPS (Switching Mode Power Supplies)
- Solar Inverters
- UPS (Uninterruptable Power Supplies)
- Energy Storages

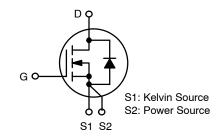
MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

| Parameter | | | Symbol | Value | Unit |
|---|-------------------------------------|-----------------------|-----------------------------------|----------------|------|
| Drain-to-Source Voltage | | | V_{DSS} | 650 | V |
| Gate-to-Source Voltage | ı | | V_{GS} | -8/+22 | V |
| Recommended Operation Values of Gate-to-Source Voltage | | V_{GSop} | -5/+18 | > | |
| Continuous Drain Current (Note 1) | Steady State | T _C = 25°C | I _D | 38 | Α |
| Power Dissipation (Note 1) | | | P _D | 148 | W |
| Continuous Drain Current (Note 1) | Steady State T _C = 100°C | | I _D | 26 | Α |
| Power Dissipation (Note 1) | | | P _D | 74 | W |
| Pulsed Drain Current (Note 2) | T _C = 25°C | | I _{DM} | 120 | Α |
| Operating Junction and Storage Temperature Range | | | T _J , T _{stg} | -55 to +175 | °C |
| Source Current (Body Diode) | | | I _S | 29 | Α |
| Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 12.9 A, L = 1 mH) (Note 3) | | | E _{AS} | 83 | mJ |
| Maximum Lead Temperature for Soldering (1/8" from case for 5 s) | | | TL | 260 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- 2. Repetitive rating, limited by max junction temperature.
- 3. E_{AS} of 83 mJ is based on starting T_J = 25°C; L = 1 mH, I_{AS} = 12.9 A, V_{DD} = 50 V, V_{GS} = 18 V.

| V _{(BR)DSS} | R _{DS(ON)} MAX | I _D MAX |
|----------------------|-------------------------|--------------------|
| 650 V | 85 mΩ @ 18 V | 38 A |

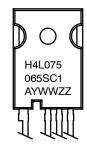


N-CHANNEL MOSFET



TO-247-4LD CASE 340CJ

MARKING DIAGRAM



H4L075065SC1 = Specific Device Code

A = Assembly Location

Y = Year

WW = Work Week

ZZ = Lot Traceability

ORDERING INFORMATION

| Device | Package | Shipping | |
|-----------------|------------|--------------------|--|
| NTH4L075N065SC1 | TO-247-4LD | 30 Units / Tube | |

Table 1. THERMAL RESISTANCE MAXIMUM RATINGS

| Parameter | Symbol | Max | Unit |
|---|-----------------|------|------|
| Junction-to-Case - Steady State (Note 1) | $R_{	heta JC}$ | 1.01 | °C/W |
| Junction-to-Ambient - Steady State (Note 1) | $R_{\theta JA}$ | 40 | |

Table 2. ELECTRICAL CHARACTERISTICS (T. J = 25°C unless otherwise specified)

| Parameter | Symbol | Test Condition | | Min | Тур | Max | Unit |
|--|--------------------------------------|--|--------------------------|-----|------|----------|------|
| OFF CHARACTERISTICS | <u> </u> | | | | 1 | | |
| Drain-to-Source Breakdown Voltage | V _{(BR)DSS} | V _{GS} = 0 V, I _D = 1 mA | | 650 | - | - | V |
| Drain-to-Source Breakdown Voltage Temperature Coefficient | V _{(BR)DSS} /T _J | I _D = 20 mA, referenced to 25°C | | - | 0.15 | - | V/°C |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{GS} = 0 V, | T _J = 25°C | - | _ | 10 | μΑ |
| | | V _{DS} = 650 V | T _J = 175°C | - | _ | 1 | mA |
| Gate-to-Source Leakage Current | I _{GSS} | $V_{GS} = +18/-5 \text{ V}, V_{DS}$ | = 0 V | - | _ | 250 | nA |
| ON CHARACTERISTICS (Note 2) | • | | | | • | | |
| Gate Threshold Voltage | V _{GS(TH)} | $V_{GS} = V_{DS}$, $I_D = 5 \text{ mA}$ | | 1.8 | 2.8 | 4.3 | V |
| Recommended Gate Voltage | V_{GOP} | | | -5 | _ | +18 | V |
| Drain-to-Source On Resistance | R _{DS(on)} | V _{GS} = 15 V, I _D = 15 A, | T _J = 25°C | - | 75 | - | mΩ |
| | | V _{GS} = 18 V, I _D = 15 A, | T _J = 25°C | - | 57 | 85 | |
| | | V _{GS} = 18 V, I _D = 15 A, | T _J = 175°C | - | 68 | - | |
| Forward Transconductance | 9 _{FS} | V _{DS} = 10 V, I _D = 15 A | | - | 9 | - | S |
| CHARGES, CAPACITANCES & GATE RES | SISTANCE | | | | I | <u> </u> | I |
| Input Capacitance | C _{ISS} | V _{GS} = 0 V, f = 1 MHz, V _{DS} = 325 V | | - | 1196 | - | pF |
| Output Capacitance | C _{OSS} | | | _ | 107 | _ | |
| Reverse Transfer Capacitance | C _{RSS} | | | - | 9 | - | |
| Total Gate Charge | Q _{G(TOT)} | $V_{GS} = -5/18 \text{ V}, V_{DS} = 520 \text{ V},$ $I_{D} = 15 \text{ A}$ $f = 1 \text{ MHz}$ | | - | 61 | _ | nC |
| Gate-to-Source Charge | Q _{GS} | | | - | 19 | - | |
| Gate-to-Drain Charge | Q_{GD} | | | - | 18 | - | |
| Gate-Resistance | R _G | | | - | 5.8 | - | Ω |
| SWITCHING CHARACTERISTICS | • | • | | | 1 | 1 | |
| Turn-On Delay Time | t _{d(ON)} | $V_{GS} = -5/18 \text{ V}, V_{DS} =$ | 400 V, | - | 10 | - | ns |
| Rise Time | t _r | I_D = 15 A, R_G = 2.2 Ω Inductive load | | - | 12 | _ | |
| Turn-Off Delay Time | t _{d(OFF)} | 1 | | - | 20 | - | |
| Fall Time | t _f | 1 | | - | 7 | - | |
| Turn-On Switching Loss | E _{ON} | | | _ | 38 | _ | μJ |
| Turn-Off Switching Loss | E _{OFF} | | | - | 16 | _ | |
| Total Switching Loss | E _{tot} | | | - | 54 | - | |
| DRAIN-SOURCE DIODE CHARACTERIST | ics | • | | • | | | |
| Continuous Drain-Source Diode Forward Current | I _{SD} | $V_{GS} = -5 \text{ V}, T_{J} = 25^{\circ}\text{C}$ | ; | _ | - | 29 | А |
| Pulsed Drain-Source Diode Forward Current (Note 2) | I _{SDM} | | | _ | - | 120 | |
| Forward Diode Voltage | V _{SD} | V _{GS} = -5 V, I _{SD} = 15 A | A, T _J = 25°C | - | 4.4 | _ | V |

Table 2. ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified) (continued)

| | \ 0 | 1 / \ | , | | | | | |
|--------------------------------|------------------------------------|---|-----|-----|-----|------|--|--|
| Parameter | Symbol | Test Condition | Min | Тур | Max | Unit | | |
| DRAIN-SOURCE DIODE CHARACTERIS | DRAIN-SOURCE DIODE CHARACTERISTICS | | | | | | | |
| Reverse Recovery Time | t _{RR} | V _{GS} = -5/18 V, I _{SD} = 15 A, dI _S /dt = 1000 A/μs | - | 16 | - | ns | | |
| Reverse Recovery Charge | Q_{RR} | αι _S /αt = 1000 A/μs | - | 72 | - | nC | | |
| Reverse Recovery Energy | E _{REC} | | - | 7.4 | - | μJ | | |
| Peak Reverse Recovery Current | I _{RRM} | | _ | 9 | - | Α | | |
| Charge Time | Ta | | - | 9 | - | ns | | |
| Discharge Time | Tb | | - | 7 | - | ns | | |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS

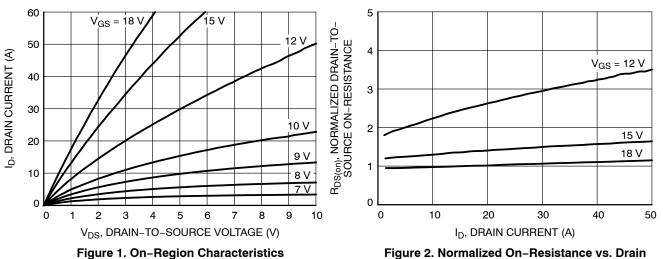
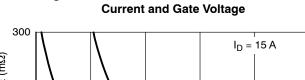


Figure 1. On-Region Characteristics



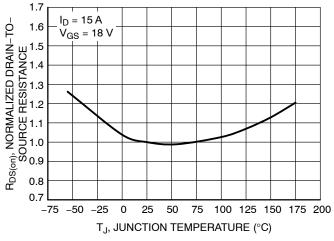


Figure 3. On-Resistance Variation with Temperature

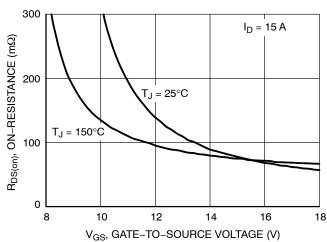


Figure 4. On-Resistance vs. Gate-to-Source Voltage

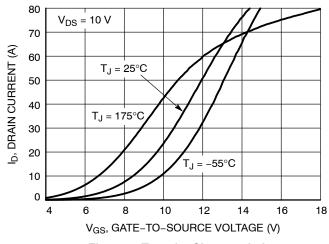


Figure 5. Transfer Characteristics

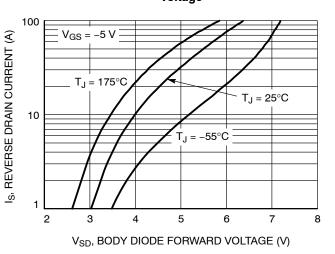
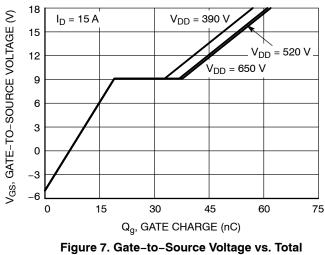


Figure 6. Diode Forward Voltage vs. Current

TYPICAL CHARACTERISTICS (CONTINUED)

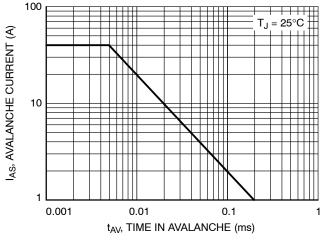
10000



Ciss 1000 CAPACITANCE (pF) 100 10 f = 1 MHz $V_{GS} = 0 V$ 1 10 650 0.1 100 V_{DS}, DRAIN-TO-SOURCE VOLTAGE (V)

Charge

Figure 8. Capacitance vs. Drain-to-Source Voltage



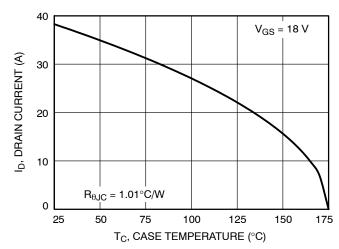
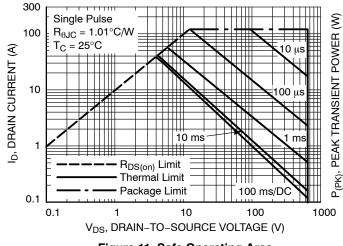


Figure 9. Unclamped Inductive Switching Capability

Figure 10. Maximum Continuous Drain **Current vs. Case Temperature**



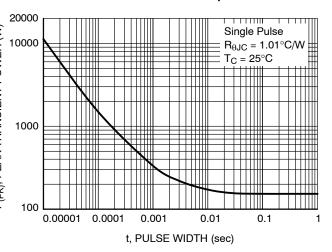


Figure 11. Safe Operating Area

Figure 12. Single Pulse Maximum Power Dissipation

TYPICAL CHARACTERISTICS (CONTINUED)

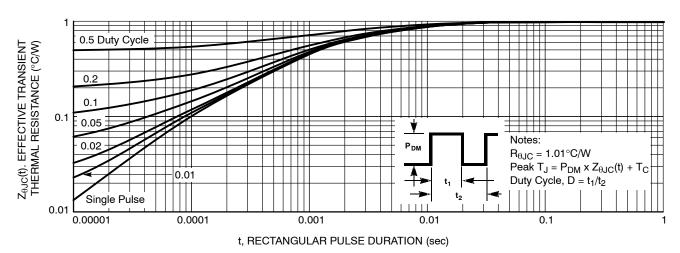


Figure 13. Junction-to-Case Thermal Response

 \emptyset p1

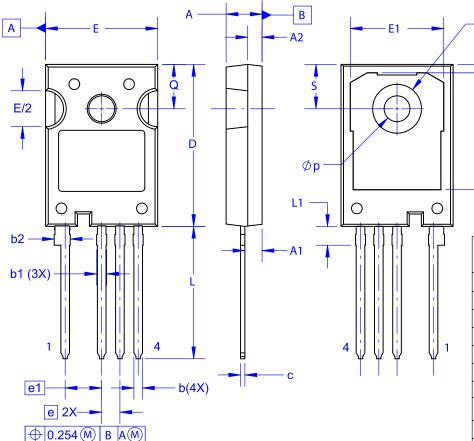
D1

D2



TO-247-4LD CASE 340CJ **ISSUE A**

DATE 16 SEP 2019



NOTES:

- A. NO INDUSTRY STANDARD APPLIES TO THIS PACKAGE.
 B. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD
 FLASH, AND TIE BAR EXTRUSIONS.
 C. ALL DIMENSIONS ARE IN MILLIMETERS.
 D. DRAWING CONFORMS TO ASME Y14.5-2009.

| DIM | MILLIMETERS | | | | | |
|-----|-------------|----------|-------|--|--|--|
| DIM | MIN | NOM | MAX | | | |
| Α | 4.80 | 5.00 | 5.20 | | | |
| A1 | 2.10 | 2.40 | 2.70 | | | |
| A2 | 1.80 | 2.00 | 2.20 | | | |
| b | 1.07 | 1.20 | 1.33 | | | |
| b1 | 1.20 | 1.40 | 1.60 | | | |
| b2 | 2.02 | 2.22 | 2.42 | | | |
| С | 0.50 | 0.60 | 0.70 | | | |
| D | 22.34 | 22.54 | 22.74 | | | |
| D1 | 16.00 | 16.25 | 16.50 | | | |
| D2 | 0.97 | 1.17 | 1.37 | | | |
| е | 2.54 BSC | | | | | |
| e1 | 5 | 5.08 BSC | | | | |
| E | 15.40 | 15.60 | 15.80 | | | |
| E1 | 12.80 | 13.00 | 13.20 | | | |
| E/2 | 4.80 | 5.00 | 5.20 | | | |
| L | 18.22 | 18.42 | 18.62 | | | |
| L1 | 2.42 | 2.62 | 2.82 | | | |
| р | 3.40 | 3.60 | 3.80 | | | |
| p1 | 6.60 | 6.80 | 7.00 | | | |
| Q | 5.97 | 6.17 | 6.37 | | | |
| S | 5.97 | 6.17 | 6.37 | | | |

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